

Innovative Service Around the Globe **YAGEO** 400-0744-078

# DATA SHEET

GENERAL PURPOSE CHIP RESISTORS RC0805 (Pb Free) 5%; 1%







<u>SCOPE</u>

This specification describes RC0805 series chip resistors with lead-free terminations made by thick film process.

SERIES

RC

#### ORDERING INFORMATION

**Chip Resistor Surface Mount** 

Part number is identified by the series, size, tolerance, packing type, temperature coefficient, taping reel and resistance value.

#### YAGEO ORDERING CODE

#### CTC CODE

### RC0805 X X X XX XXXX L

(1) (2) (3) (4) (5) (6)

#### (I) TOLERANCE

 $F = \pm 1\%$ | = ±5%

#### (2) PACKAGING TYPE

R = Paper/PE taping reel

#### (3) TEMPERATURE COEFFICIENT OF RESISTANCE

- = Base on spec

#### (4) TAPING REEL

- 07 = 7 inch dia. Reel
- 10 = 10 inch dia. Reel (not preferred)
- 13 = 13 inch dia. Reel

#### (5) RESISTANCE VALUE

5R6, 56R, 560R, 5K6, 56K, 22M.

#### (6) RESISTOR TERMINATIONS

L = Lead free terminations (pure Tin)

#### **ORDERING EXAMPLE**

0805 (Pb Free)

The ordering code of a RC0805 chip resistor, value 56  $\Omega$  with  $\pm1\%$  tolerance, supplied in 7-inch tape reel is: RC0805FR-0756RL.

#### NOTE

- The "L" at the end of the code is only for ordering. On the reel label, the standard CTC will be mentioned an additional stamp "LFP"= lead free production.
- 2. Products with lead in terminations fulfil the same requirements as mentioned in this datasheet.
- Products with lead in terminations will be phased out in the coming months (before July 1st, 2006)



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Chip Resistor Surface MountRCSERIES0805 (Pb Free)

#### MARKING

 RC0805

 E-24 series: 3 digits

 Fig. 1
 Value=10 KΩ

 Fig. 1
 Value=10 KΩ

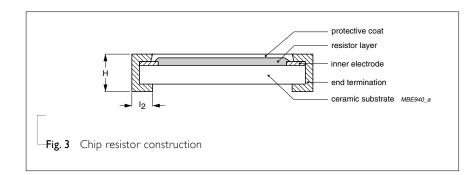


Both E-24 and E-96 series: 4 digits First three digits for significant figure and 4th digit for number of zeros

For marking codes, please see EIA-marking code rules in data sheet "Chip resistors instruction".

#### CONSTRUCTION

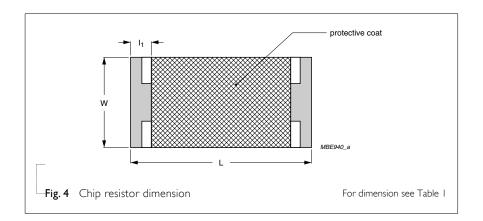
The resistors are constructed out of a high-grade ceramic body. Internal metal electrodes are added at each end and connected by a resistive paste. The composition of the paste is adjusted to give the approximate required resistance and laser cutting of this resistive layer that achieves tolerance trims the value. The resistive layer is covered with a protective coat and printed with the



resistance value. Finally, the two external terminations (pure Tin) are added. See fig. 3.

#### **DIMENSIONS**

Table I	
TYPE	RC0805
L (mm)	2.00 ±0.10
W (mm)	1.25 ±0.10
H (mm)	0.50 ±0.10
l <sub>l</sub> (mm)	0.35 ±0.20
l <sub>2</sub> (mm)	0.35 ±0.20





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Chip Resistor Surface Mount RC SERIES 0805 (Pb Free)

#### ELECTRICAL CHARACTERISTICS

Table 2			
CHARACTERISTICS	RC0805 1/8 W		
Operating Temperature Range	–55 ℃ to +155 ℃		
Maximum Working Voltage	150 V		
Maximum Overload Voltage	300 V		
Dielectric Withstanding Voltage		300 V	
	5% (E24)	I $\Omega$ to 22 M $\Omega$	
Resistance Range	1% (E96)	I $\Omega$ to 10 $M\Omega$	
	Zero Ohm Ju	$mper < 0.05 \ \Omega$	
Temperature Coefficient	$10 \Omega < R \le 10 M\Omega$	±100 ppm/°C	
Temperature Coencient	$R \le 10 \Omega; R > 10 M\Omega$	±200 ppm/°C	
Jumper Criteria	Rated Current	2.0 A	
	Maximum Current	5.0 A	

## FOOTPRINT AND SOLDERING PROFILES

For recommended footprint and soldering profiles, please see the special data sheet "Chip resistors mounting".

#### ENVIRONMENTAL DATA

For material declaration information (IMDS-data) of the products, please see the separated info "Environmental data".

#### PACKING STYLE AND PACKAGING QUANTITY

 Table 3
 Packing style and packaging quantity

PRODUCT TYPE	PACKING STYLE	REEL DIMENSION	QUANTITY PER REEL
RC0805	Paper / PE Taping Reel (R)	7" (178 mm)	5,000 units
		10" (254 mm) / not preferred	10,000 units
		13" (330 mm)	20,000 units

#### NOTE

1. For Paper/PE tape and reel specification/dimensions, please see the special data sheet "Packing" document.





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#### FUNCTIONAL DESCRIPTION

#### **POWER RATING**

RC0805 rated power at 70°C is 1/8 W

#### **R**ATED VOLTAGE

The DC or AC (rms) continuous working voltage corresponding to the rated power is determined by the following formula:

 $V=\sqrt{(P \times R)}$ 

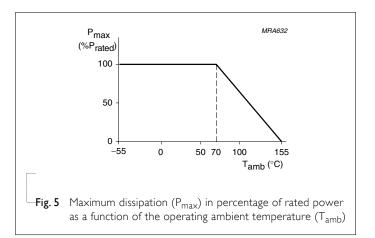
Where

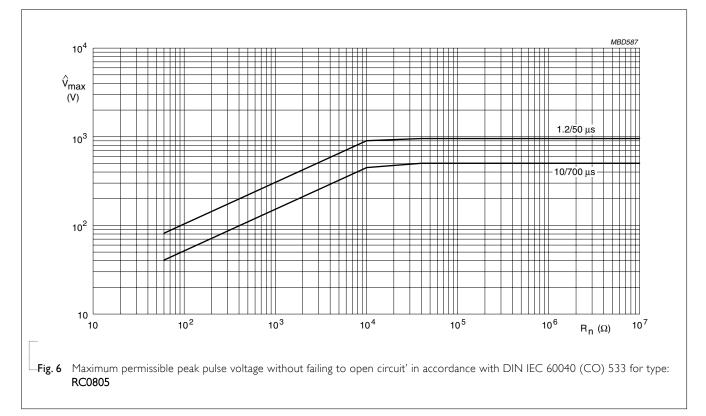
V=Continuous rated DC or AC (rms) working voltage (V)

P=Rated power (W)

R=Resistance value ( $\Omega$ )

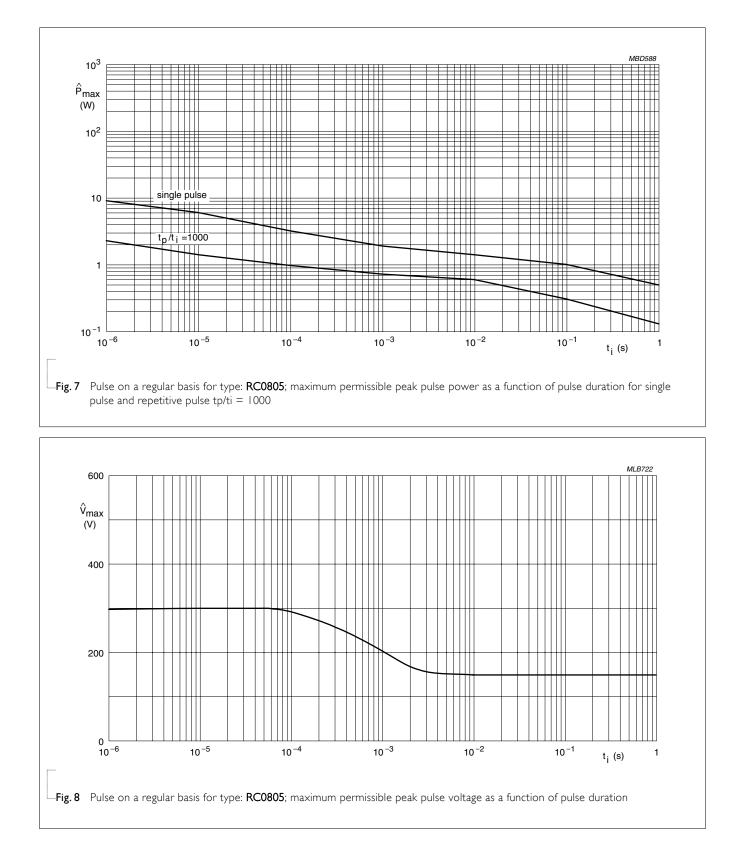
#### PULSE LOADING CAPABILITIES







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#### TESTS AND REQUIREMENTS

Table 4 Test condition, procedure and requirements

EST	TEST METHOD	PROCEDURE	REQUIREMENTS
Temperature Coefficient of	MIL-STD-202F-method 304;	At +25/–55 °C and +25/+125 °C	Refer to table 3
Resistance	JIS C 5202-4.8	Formula:	
(T.C.R.)		T.C.R= $\frac{R_2-R_1}{R_1(t_2-t_1)} \times 10^6 \text{ (ppm/°C)}$	
		Where t <sub>1</sub> =+25 °C or specified room temperature	
		$t_2$ =–55 °C or +125 °C test temperature	
		$R_1$ =resistance at reference temperature in ohms	
		$R_2$ =resistance at test temperature in ohms	
Thermal Shock	MIL-STD-202F-method 107G;	At -65 (+0/-10) °C for 2 minutes and at +155	±(0.5%+0.05 Ω) for 1% tol.
	IEC 60115-1 4.19	(+10/–0) °C for 2 minutes; 25 cycles	$\pm(1.0\%{+}0.05~\Omega)$ for 5% tol.
Low	MIL-R-55342D-Para 4.7.4	At -65 (+0/-5) °C for I hour; RCWV applied	±(0.5%+0.05 Ω) for 1% tol .
Temperature		for 45 (+5/–0) minutes	$\pm (1.0\% {+} 0.05~\Omega)$ for 5% tol.
Operation			No visible damage
Short Time	MIL-R-55342D-Para 4.7.5;	2.5 × RCWV applied for 5 seconds at room	±(1.0%+0.05 Ω) for 1% tol.
	IEC 60115-1 4.13	temperature	$\pm$ (2.0%+0.05 Ω) for 5% tol.
			No visible damage
Insulation	MIL-STD-202F-method 302;	RCOV for 1 minute	≥10 GΩ
Resistance	IEC 60115-1 4.6.1.1	Type RC0805	
		Voltage (DC) 300 ∨	
Dielectric	MIL-STD-202F-method 301;	Maximun voltage (V <sub>rms</sub> ) applied for 1 minute	No breakdown or flashover
Withstand Voltage	IEC 60115-1 4.6.1.1	Туре RC0805	
		Voltage (AC) 300 V <sub>rms</sub>	
Resistance to	MIL-STD-202F-method 210C;	Unmounted chips; 260 $\pm$ 5 °C for 10 $\pm$ 1	$\pm(0.5\%{+}0.05~\Omega)$ for 1% tol.
Soldering Heat	IEC 60115-1 4.18	seconds	$\pm (1.0\% {+} 0.05~\Omega)$ for 5% tol.
i icat			No visible damage
Life	MIL-STD-202F-method 108A;	At 70±2 °C for 1,000 hours; RCWV applied for	±(1%+0.05 Ω) for 1% tol.
	IEC 60115-1 4.25.1	1.5 hours on and 0.5 hour off	$\pm(3\%+0.05~\Omega)$ for 5% tol.

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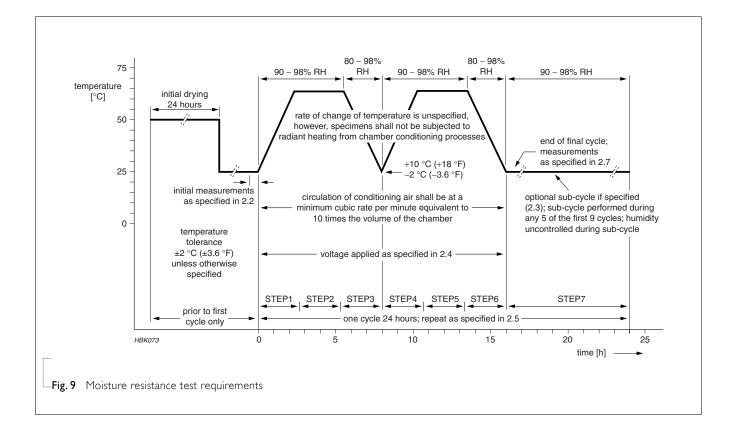
ST	TEST METHOD PROCEDURE		EST METHOD PROCEDURE REQUIREMENTS		
Solderability	MIL-STD-202F-method 208A;	Solder bath at 245±3 °C	Well tinned (≥95% cove	ered)	
	IEC 60115-1 4.17	Dipping time: 2±0.5 seconds	No visible damage		
Bending	JIS C 5202.6.14;	Resistors mounted on a 90 mm glass epoxy	$\pm$ (1.0%+0.05 Ω) for 1% tol. $\pm$ (1.0%+0.05 Ω) for 5% tol. No visible damage		
Strength	IEC 60115-1 4.15	resin PCB (FR4)			
		Bending: 5 mm			
Resistance to Solvent	MIL-STD-202F-method 215; IEC 60115-1 4.29	lsopropylalcohol (C $_3H_7OH$ ) or dichloromethane (CH $_2CI_2$ ) followed by brushing	No smeared		
Noise	JIS C 5202 5.9;	Maximum voltage (V <sub>ms</sub> ) applied.	Resistors range	Value	
	IEC 60115-1 4.12		R < 100 Ω	10 dl	
			$100 \ \Omega \le R < 1 \ K\Omega$	20 dł	
			$  K\Omega \le R <  0 K\Omega$	30 dE	
			$10 \text{ K}\Omega \leq \text{R} < 100 \text{ K}\Omega$	40 dł	
			$100 \text{ K}\Omega \leq \text{R} < 1 \text{ M}\Omega$	46 dl	
			$  M\Omega \leq R \leq 22 M\Omega$	48 df	
			<u>·····</u>		
Humidity	JIS C 5202 7.5;	I,000 hours; 40±2 °C; 93(+2/–3)% RH	±(0.5%+0.05 Ω) for 1%		
Humidity (steady state)	JIS C 5202 7.5; IEC 60115-8 4.24.8	I,000 hours; 40±2 °C; 93(+2/–3)% RH RCWV applied for I.5 hours on and 0.5 hour off		ó tol.	
•	-	· · · · ·	±(0.5%+0.05 Ω) for 1%	ó tol.	
(steady state)	IEC 60115-8 4.24.8	RCWV applied for 1.5 hours on and 0.5 hour off	±(0.5%+0.05 Ω) for 1% ±(2.0%+0.05 Ω) for 5%	ó tol.	
(steady state) Leaching Intermittent	IEC 60115-8 4.24.8 EIA/IS 4.13B;	RCWV applied for 1.5 hours on and 0.5 hour off Solder bath at 260±5 °C Dipping time: 30±1 seconds At room temperature; 2.5 × RCWV applied for	±(0.5%+0.05 Ω) for 1% ±(2.0%+0.05 Ω) for 5%	ś tol. ś tol.	
(steady state) Leaching	IEC 60115-8 4.24.8 EIA/IS 4.13B; IEC 60115-8 4.18	RCWV applied for 1.5 hours on and 0.5 hour off Solder bath at 260±5 °C Dipping time: 30±1 seconds	±(0.5%+0.05 Ω) for 1% ±(2.0%+0.05 Ω) for 5% No visible damage	5 tol. 5 tol. 5 tol.	
(steady state) Leaching Intermittent	IEC 60115-8 4.24.8 EIA/IS 4.13B; IEC 60115-8 4.18	RCWV applied for 1.5 hours on and 0.5 hour off Solder bath at 260±5 °C Dipping time: 30±1 seconds At room temperature; 2.5 × RCWV applied for 1 second on and 25 seconds off; total 10,000	±(0.5%+0.05 Ω) for 1% ±(2.0%+0.05 Ω) for 5% No visible damage ±(1.0%+0.05 Ω) for 1%	5 tol. 5 tol. 5 tol.	
(steady state) Leaching Intermittent Overload Resistance to	IEC 601 15-8 4.24.8 EIA/IS 4.13B; IEC 601 15-8 4.18 JIS C 5202 5.8	RCWV applied for 1.5 hours on and 0.5 hour off Solder bath at 260±5 °C Dipping time: 30±1 seconds At room temperature; 2.5 × RCWV applied for 1 second on and 25 seconds off; total 10,000 cycles	±(0.5%+0.05 Ω) for 1% ±(2.0%+0.05 Ω) for 5% No visible damage ±(1.0%+0.05 Ω) for 1%	5 tol. 5 tol. 5 tol. 5 tol.	
(steady state) Leaching Intermittent Overload Resistance to Vibration	IEC 601 15-8 4.24.8 EIA/IS 4.13B; IEC 601 15-8 4.18 JIS C 5202 5.8 On request	RCWV applied for 1.5 hours on and 0.5 hour off         Solder bath at 260±5 °C         Dipping time: 30±1 seconds         At room temperature; 2.5 × RCWV applied for         1 second on and 25 seconds off; total 10,000         cycles         On request	$\pm$ (0.5%+0.05 Ω) for 1% ±(2.0%+0.05 Ω) for 5% No visible damage ±(1.0%+0.05 Ω) for 1% ±(2.0%+0.05 Ω) for 5%	5 tol. 5 tol. 5 tol. 5 tol. 5 tol.	



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REVISION HISTORY

REVISION	DATE	CHANGE NOTIFICATION	DESCRIPTION
Version 2	Sep 03, 2004	-	- Test method and procedure updated
			- PE tape added (paper tape will be replaced by PE tape)

